FEATURES AND SPECIFICATIONS

Molex's Mobile Phone Camera Sockets Offer Versatility for Mounting Camera Modules

The mobile phone has become more than just an audio communication device over the past few years. With advances in cellular networks and camera modules, improved bandwidths have provided mobile phone manufacturers more options to include cameras and video-conference capabilities.

Visual transmission is via the camera module connected to the camera socket. The entire assembly is either soldered onto flex or PCB of the mobile phone. These sockets allow mobile phone makers to reduce their bills-ofmaterial (BOM) due to the socket's compact design and simple assembly process. Another major benefit arising from the size of the sockets is the reduction in space.

Molex offers a wide range of socket configurations that includes application extraction tooling to disengage the camera module from the socket.

Camera Sockets

47249 8 x 8, Top Mount
47337 8.5 x 8.5, Top Mount
47356 6 x 6, Mid Mount with Cap
47357 8 x 8, Mid Mount
47578 6 x 6, Top Mount



| Features | Benefits |
|--|---|
| • Low profile | • Excellent for Slim type cell phone |
| • High reliability | • Stable high quality image |
| • Side contact and bottom contact solution | • Options for module mating design |
| • Top mount and mid mount solution | Provides various height options |
| • Top cover available for | • EMI and module holding |
| Module extraction tool available | • Allows re-work |

SPECIIFICATIONS

Reference Information Packaging: Embossed Tape on Reel UL File No.: Pending CSA File No.: Pending Mates With: Respective camera module Designed In: mm

Electrical Voltage: 50V Current: 0.5A Contact Resistance: 60 milliohms max. Dielectric Withstanding Voltage: 150V AC Insulation Resistance: 400 Megohms min.

Mechanical

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Unmating Force: 1.00N Durability: 30 cycles

Physical Housing: PA Polyamide (nylon), UL 94V-0 Contact: Copper Alloy Plating: Contact Area — 12 µ"Gold Solder Tail Area — Gold Underplating — Nickel PCB Thickness: Operating Temperature: -55°C to +85°C



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ORDERING INFORMATION

| Description | Order No. | lmager Dim. (mm) | PCB Mounting Type | Pitch (mm) | Circuits | Physical Size (L x W x H) in mm | Contact Type | Capacity (Mega Pixels) |
|------------------|------------|------------------------|-------------------------|---------------|----------|------------------------------------|-----------------|---------------------------|
| | 47578-0001 | 6 x 6 | Тор | 0.65 | 20 | 8.20 x 8.20 x 4.00 | Bottom | 0.30 MP (VGA) |
| | 47356-0020 | 6 x 6 | Mid | 0.65 | 20 | 7.90 x 7.90 x 2.90 | Bottom | 0.30 MP (VGA) |
| Camera Socket | 47249-0001 | 8 x 8 | Тор | 0.90 | 24 | 10.10 x 10.10 x 4.20 | Side | 1 - 2 MP (CMOS) |
| | 47357-0001 | 8 x 8 | Mid | 0.90 | 24 | 10.18 x 10.18 x 3.35 | Side | 1 – 2 MP (CMOS) |
| | 47337-0001 | 8.5 x 8.5 | Тор | 0.90 | 24 | 10.60 x 10.60 x 4.20 | Side | 2.0 MP (CMOS) |



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